

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

SSM3K02F

High Speed Switching Applications

Unit: mm

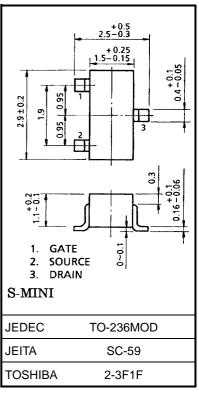
- · Small package
- Low on resistance: $R_{on} = 200 \text{ m}\Omega \text{ (max) (V}_{GS} = 4 \text{ V)}$

: $R_{on} = 250 \text{ m}\Omega \text{ (max) (VGS} = 2.5 \text{ V)}$

• Low gate threshold voltage: $V_{th} = 0.6 \sim 1.1 \text{ V (V}_{DS} = 3 \text{ V, I}_{D} = 0.1 \text{ mA)}$

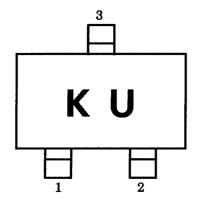
Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DS}	30	V	
Gate-source voltage		V_{GSS}	±10	V	
Drain current	DC	I _D	1.0	А	
	Pulse	I _{DP}	2.0		
Drain power dissipation		P _D	200	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

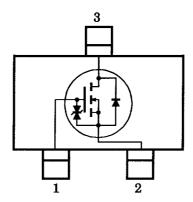


Weight: 0.012 g (typ.)

Marking



Equivalent Circuit



Handling Precaution

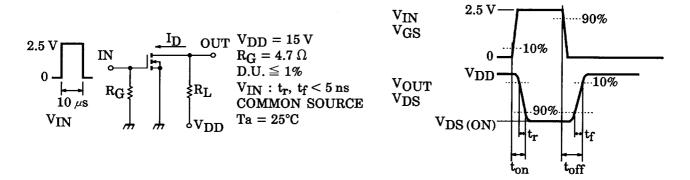
When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$		_	_	±5	μΑ
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0$		30	_	_	V
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0		_	_	1	μА
Gate threshold vo	oltage	V _{th}	$V_{DS} = 3 \text{ V}, I_{D} = 0.1 \text{ mA}$		0.6	_	1.1	V
Forward transfer	admittance	Y _{fs}	$V_{DS} = 3 \text{ V}, I_{D} = 0.5 \text{ A}$	(Note)	1.5	_	_	S
Drain-source ON resistance		R _{DS (ON)}	I _D = 0.5 A, V _{GS} = 4 V	(Note)	_	140	200	- mΩ
			I _D = 0.5 A, V _{GS} = 2.5 V	(Note)	_	180	250	
Input capacitance	•	C _{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	115	_	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz		_	24	_	pF
Output capacitance		C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	60	_	pF
Switching time	Turn-on time	t _{on}	V _{DD} = 15 V, I _D = 0.5 A,		_	52	_	20
	Turn-off time	t _{off}	$V_{GS} = 0 \sim 2.5 \text{ V}, R_{G} = 4.7 \Omega$		_	80	_	ns

Note: Pulse test

Switching Time Test Circuit



Precaution

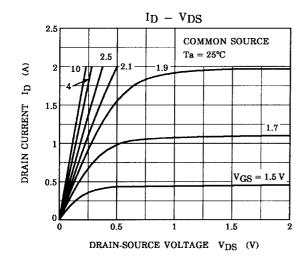
 V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = 100~\mu A$ for this product. For normal switching operation, V_{GS} (ON) requires higher voltage than V_{th} and V_{GS} (off) requires lower voltage than V_{th} .

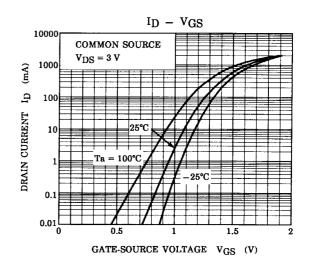
(Relationship can be established as follows: $VGS (off) < V_{th} < V_{GS} (on)$)

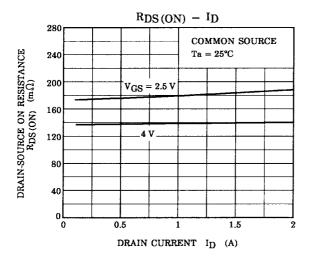
Please take this into consideration for using the device.

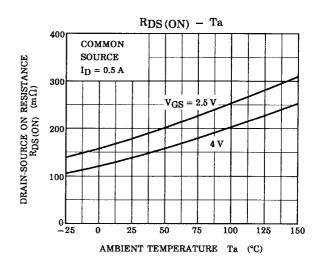
VGS recommended voltage of 2.5 V or higher to turn on this product.

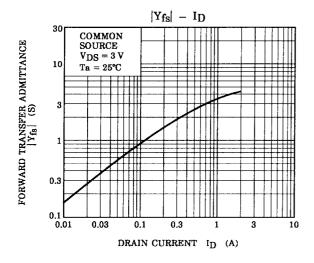
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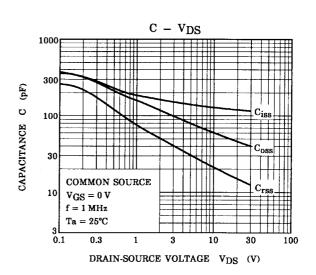


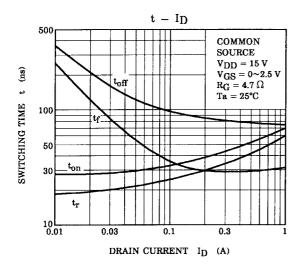


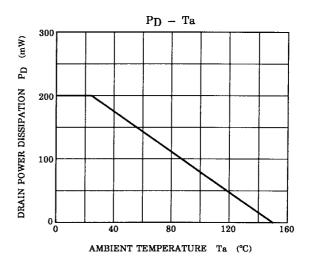












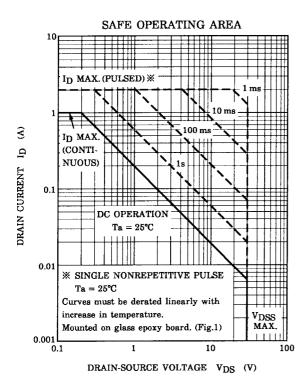




Figure 1 25.4 mm \times 25.4 mm \times 1.6 t (a Cu pad of 0.8 mm² area)

RESTRICTIONS ON PRODUCT USE

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